

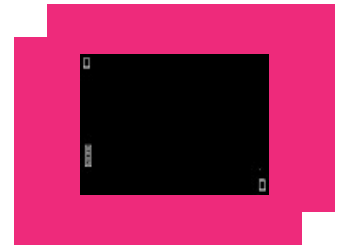
# NLTL-6273CH

## GaAs MMIC Non-Linear Transmission Line

### DEVICE OVERVIEW

#### General Description

NLTL-6273 is a MMIC non-linear transmission line (NLTL) based comb generator. This NLTL offers excellent phase noise performance over a low 0.7 to 5 GHz input frequency range with output tones beyond 40 GHz. NLTL-6273 is fabricated with GaAs Schottky diode based varactors on a 2.28 mm x 3.13 mm substrate. Both wire bondable die and connectorized modules are available.



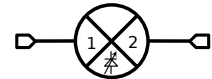
#### Features

- Low Phase Noise
- Broadband Input Frequencies
- No External DC Bias Required

#### Applications

- Comb Line Generation
- High Efficiency Multiplication
- Samplers
- Phase Locked Loops

#### Functional Block Diagram



#### Part Ordering Options

Part Number	Description	Package	Connectors	Green Status	Product Lifecycle	Export Classification
<a href="#">NLTL-6273S</a>	GaAs MMIC Non-Linear Transmission Line	S	<a href="#">Standard</a>	RoHS REACH	Released	EAR99
NLTL-6273CH	GaAs MMIC Non-Linear Transmission Line	CH	-	RoHS REACH	Released	EAR99

**Table Of Contents**

- **Device Overview**
  - General Description
  - Features
  - Applications
  - Functional Block Diagram
- **Port Configuration and Functions**
  - Port Diagram
  - Port Functions
- **Revision History**
- **Specifications**
  - Absolute Maximum Ratings
  - Package Information
  - Recommended Operating Conditions
  - Sequencing Requirements
  - Electrical Specifications
  - Typical Performance Plots
  - Residual Phase Noise
  - NLTL-6273S Typical Performance Plots
- **Die Mounting Recommendations**
  - Mounting and Bounding Recommendations
- **Operation**
  - Application Information
  - Application Circuit
  - Application Circuit Description
- **Mechanical Data**
  - Outline Drawing

**Revision History**

Revision Code	Revision Date	Comment
-	2017-08-01	Datasheet Initial Release
A	2017-09-01	Minor Clarification/Text Changes
B	2017-10-01	Corrected typos
C	2019-08-01	Added DC Current Plot

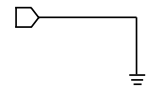
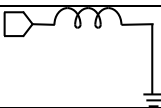
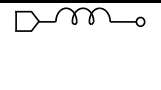
## Port Configuration and Functions

### Port Diagram

A top-down view of the NLTL-6273's CH package outline drawing is shown below. The NLTL should only be used in the forward direction, with the input and output ports given in Port Functions.



### Port Functions

Port	Function	Description	DC Equivalent Circuit
GND	Ground	CH package ground path is provided through the substrate and ground bond pads. S package ground provided through metal housing and outer coax conductor.	
Pad 1	Input	Port 1 is diode connected for the CH package and DC short for the S package.	
Pad 2	Output	Port 2 is diode connected for the CH and DC open for the S package.	

## Specifications

### Absolute Maximum Ratings

The Absolute Maximum Ratings indicate limits beyond which damage may occur to the device. If these limits are exceeded, the device may be inoperable or have a reduced lifetime.

Parameter	Maximum Rating	Unit
Maximum Operating Temperature	100	°C
Maximum Storage Temperature	125	°C
Minimum Operating Temperature	-55	°C
Minimum Storage Temperature	-65	°C

### Package Information

Parameter	Details	Rating
Dimensions	-	14.22 x 13.21 mm

### Recommended Operating Conditions

The Recommended Operating Conditions indicate the limits, inside which the device should be operated, to guarantee the performance given in Electrical Specifications. Operating outside these limits may not necessarily cause damage to the device, but the performance may degrade outside the limits of the electrical specifications. For limits, above which damage may occur, see Absolute Maximum Ratings.

Parameter	Min	Nominal	Max	Unit
Ambient Temperature	-55	25	100	°C
Input Power	16	-	26	dBm

## Sequencing Requirements

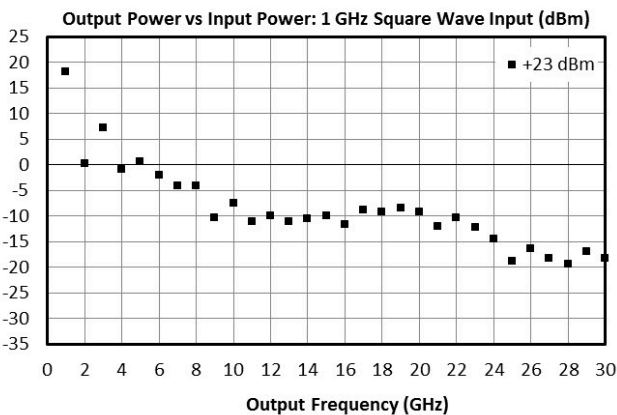
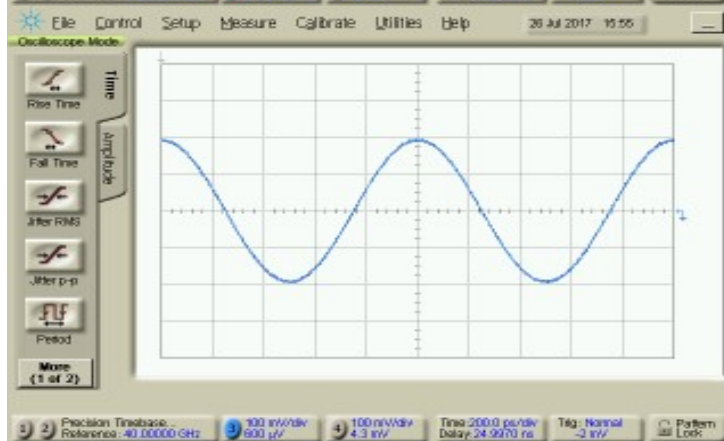
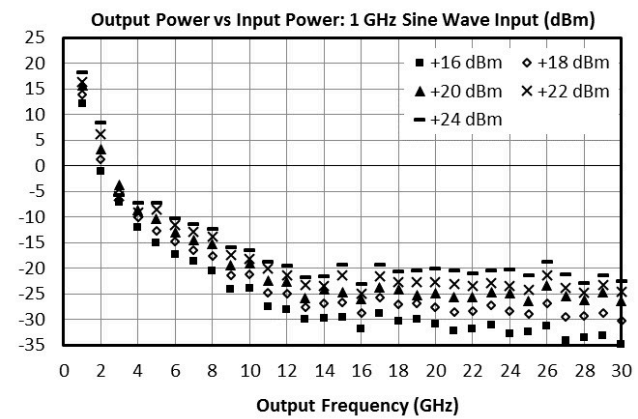
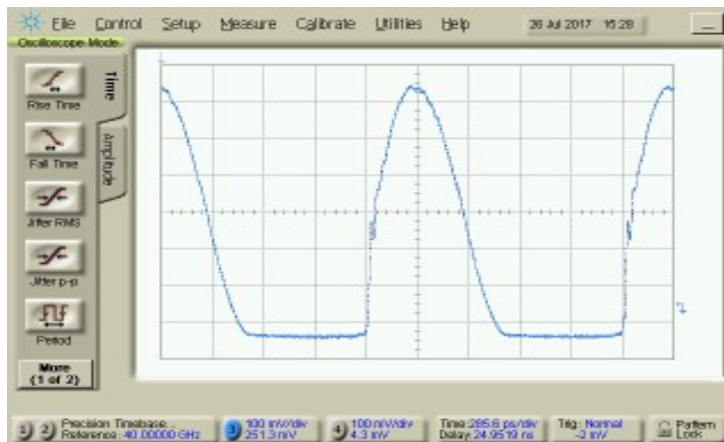
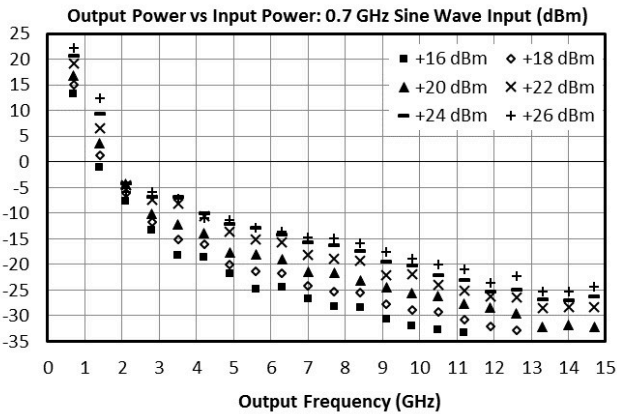
This is a passive NLTL that requires no external DC bias. Self-bias of the diodes is sufficient for operation. It is not required, but is recommended to provide a 50Ω termination to each port before applying RF power.

**Electrical Specifications**

The electrical specifications apply at Tau=+25°C in a 50Ω system. Typical data shown is for the NLTL used in the forward direction with a +20 dBm sine wave input. Min and Max limits apply only to our connectorized units and are guaranteed at Tau=+25°C. All bare die are 100% DC tested and visually inspected.

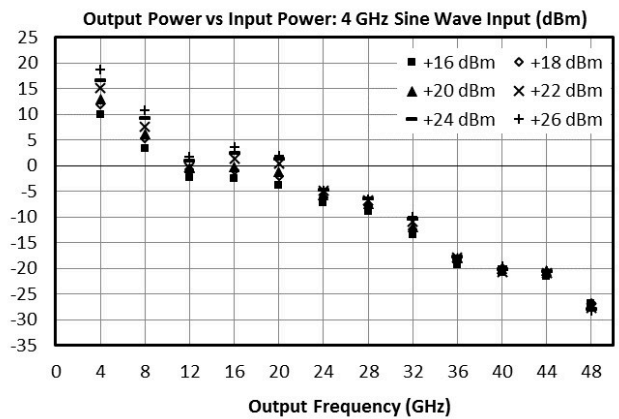
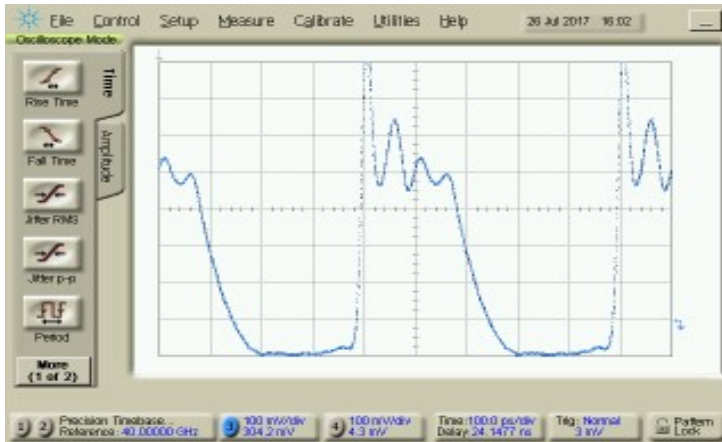
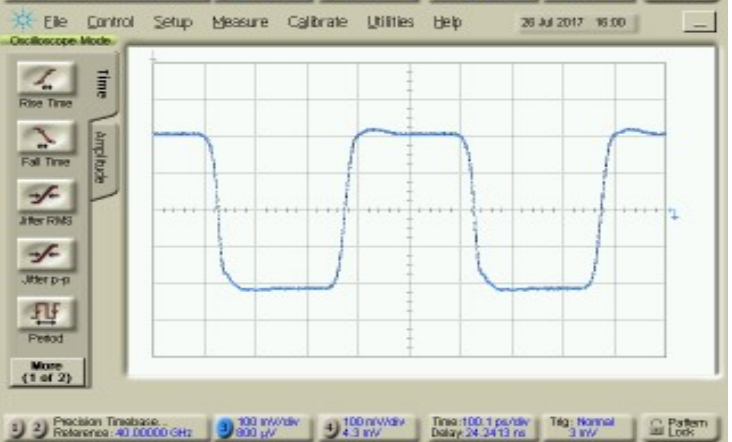
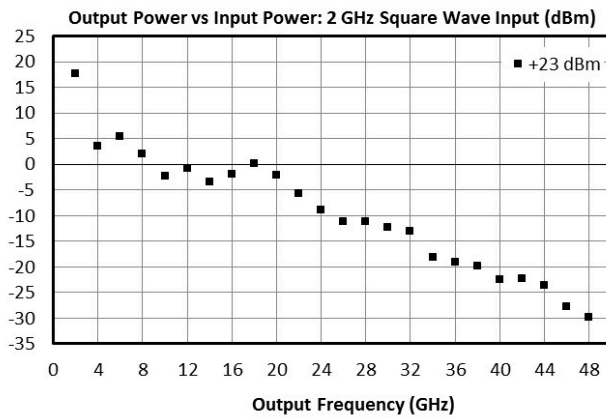
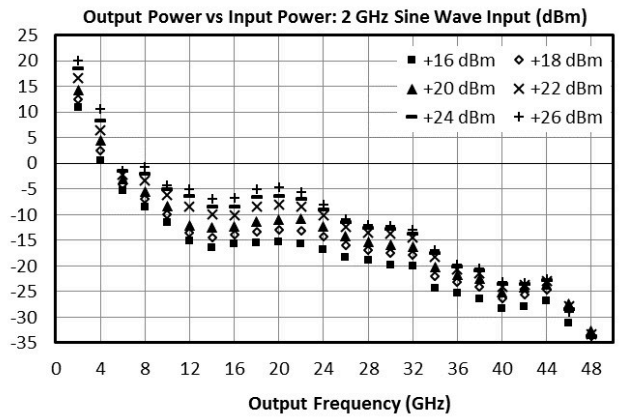
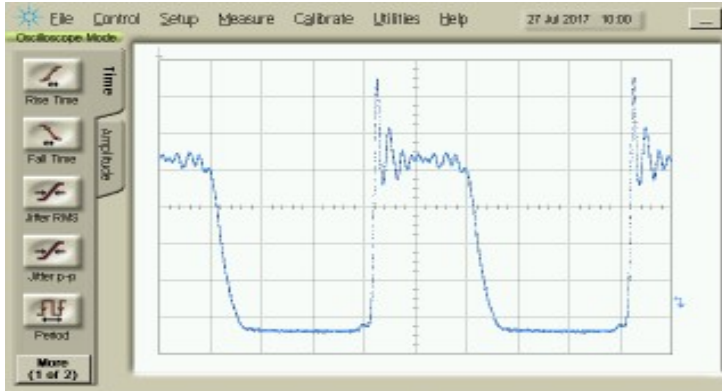
Parameter	Test Conditions	Minimum Frequency (GHz)	Maximum Frequency (GHz)	Min	Typ	Max	Unit
Input Frequency Range	-	-	-	0.7	-	5	GHz
Input Power	-	-	-	16	-	26	dBm
Maximum Output Harmonic for given Input	Input = 0.7 GHz	-	-	-	-	10	
Maximum Output Harmonic for given Input	Input = 1GHz	-	-	-	-	30	
Maximum Output Harmonic for given Input	Input = 2GHz	-	-	-	-	17	
Maximum Output Harmonic for given Input	Input = 4GHz	-	-	-	-	10	
Maximum Output Harmonic for given Input	Input = 5GHz	-	-	-	-	8	
Output Frequency Range	-	-	-	0.7	-	40	GHz

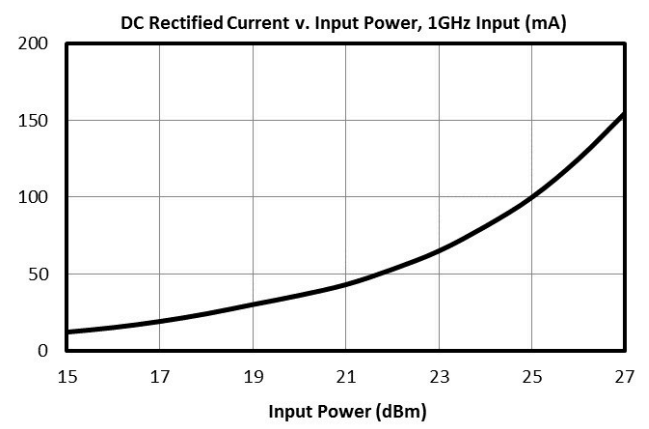
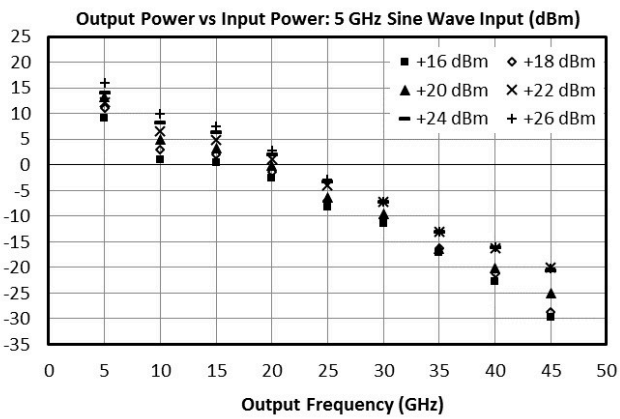
### Typical Performance Plots



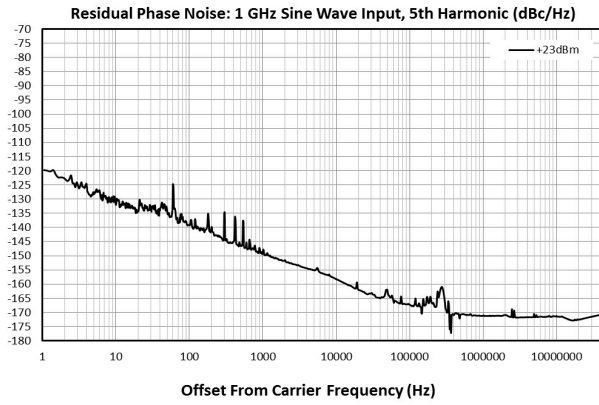
## NLTL-6273CH

### GaAs MMIC Non-Linear Transmission Line





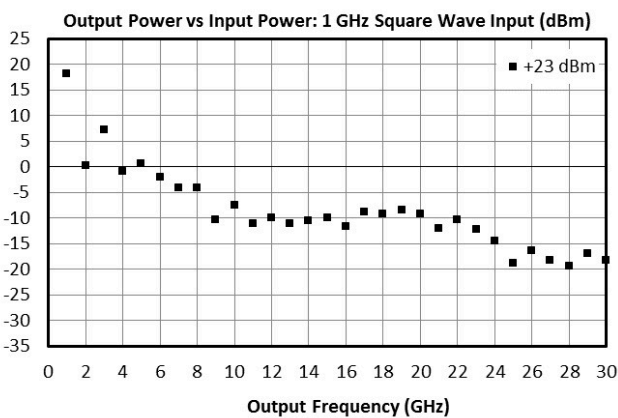
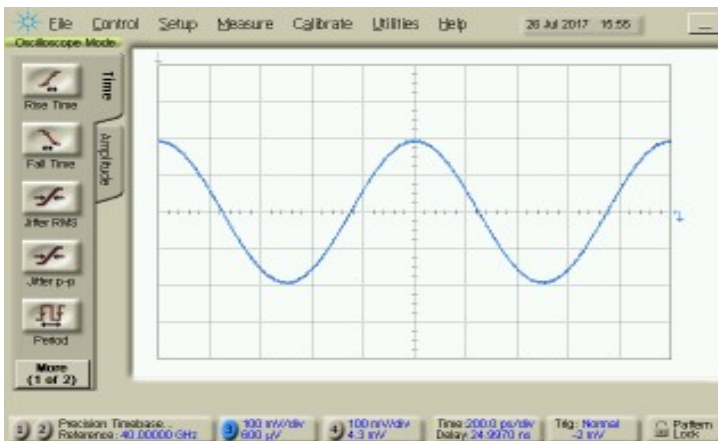
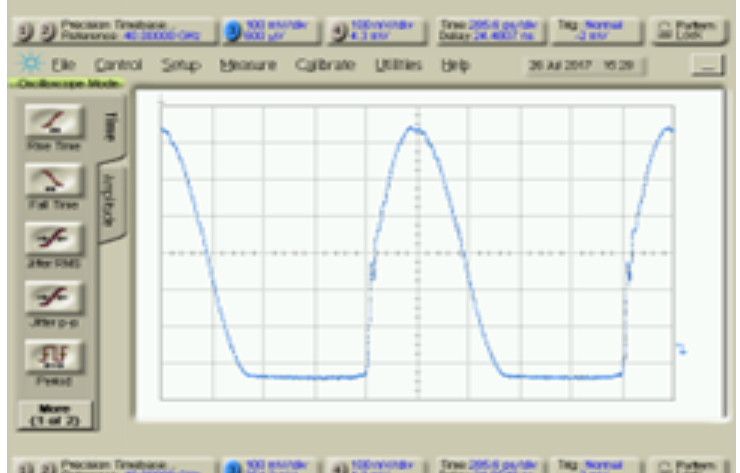
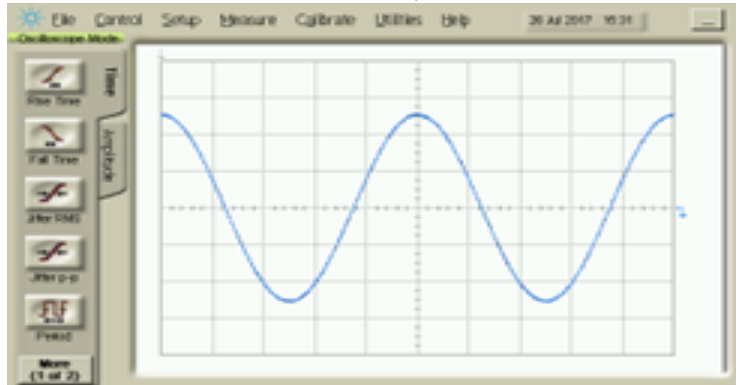
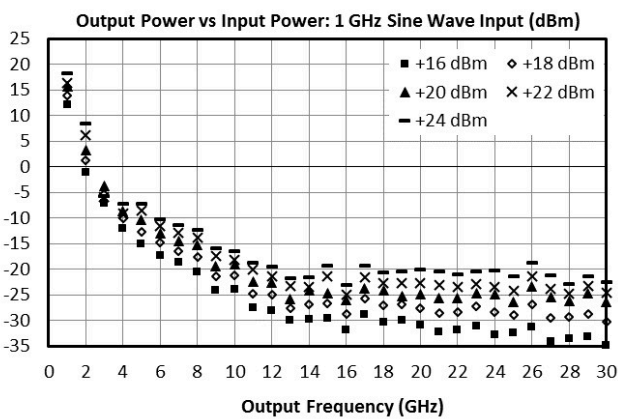
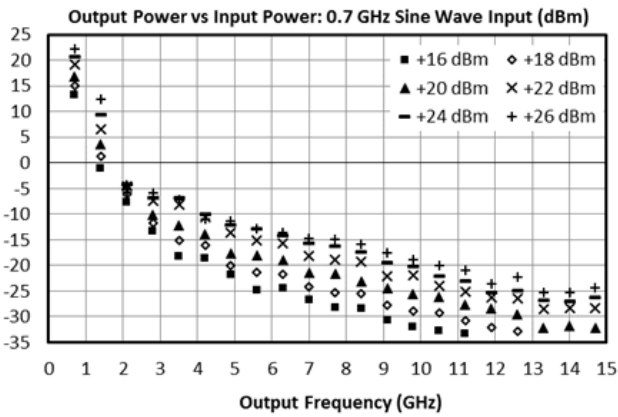
**Residual Phase Noise**



1 GHz, +23 dBm Sine Wave Input	Parameter	Min	Typical	Max	Units
5 <sup>th</sup> Output Harmonic	1 Hz Offset		-120		dBc/Hz
	10 Hz Offset		-130		
	100 Hz Offset		-140		
	1 kHz Offset		-150		
	10 kHz Offset		-160		
	100 kHz Offset		-170		
	1 MHz Offset		Thermal Floor		

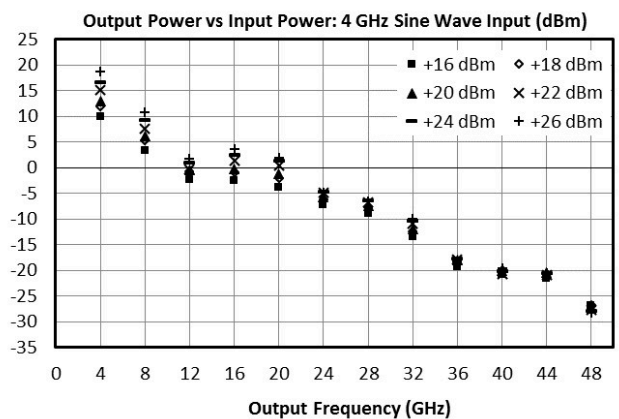
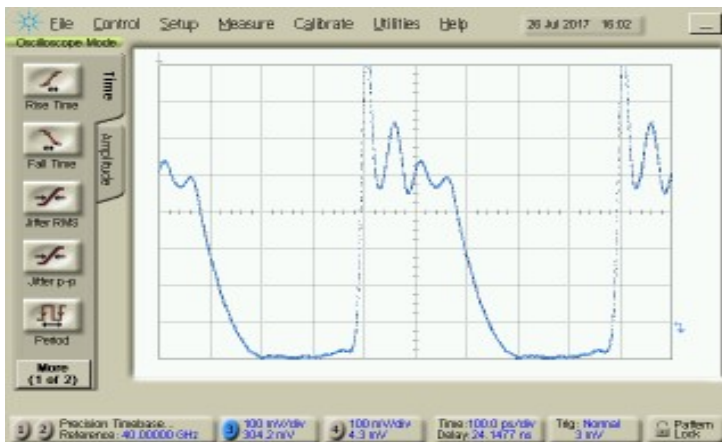
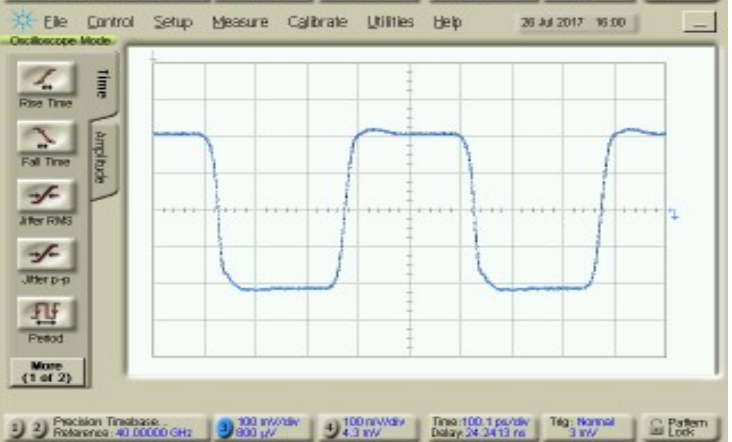
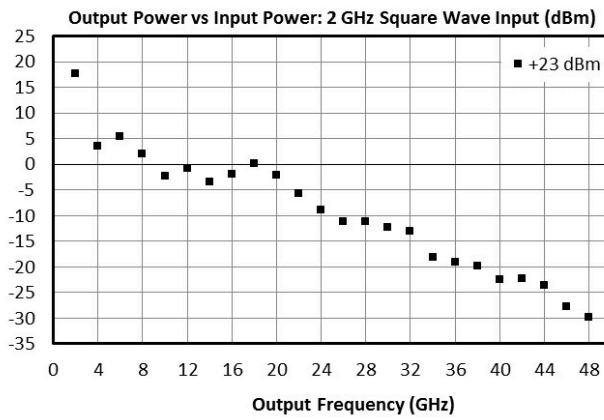
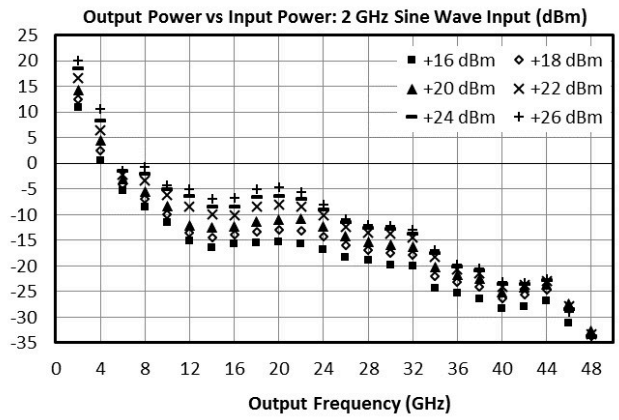
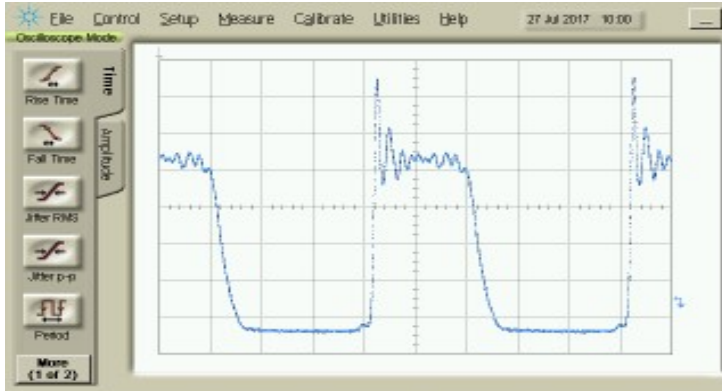
### NLTL-6273S - Typical Performance Plots

Performance plots for the connectorized module are shown for measurements where directly probed measurements of the die are unavailable. Note that the following measurements include losses from connectors and microstrip traces.



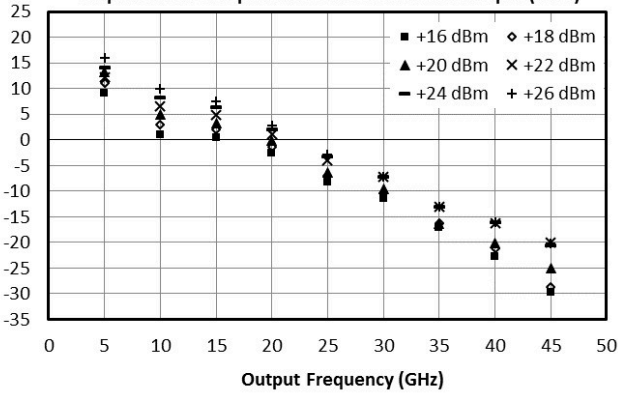
## NLTL-6273CH

### GaAs MMIC Non-Linear Transmission Line

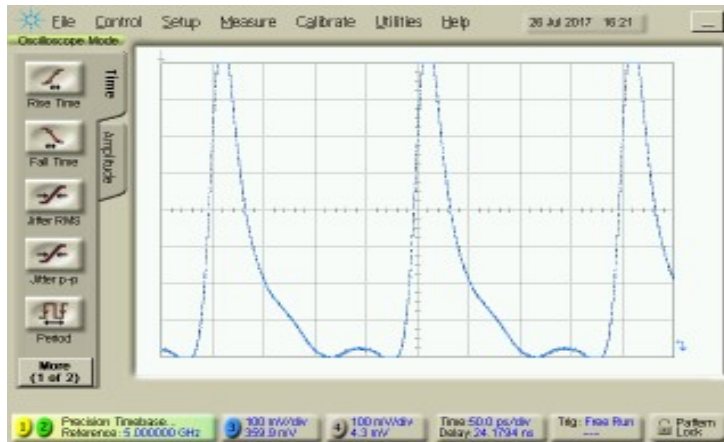
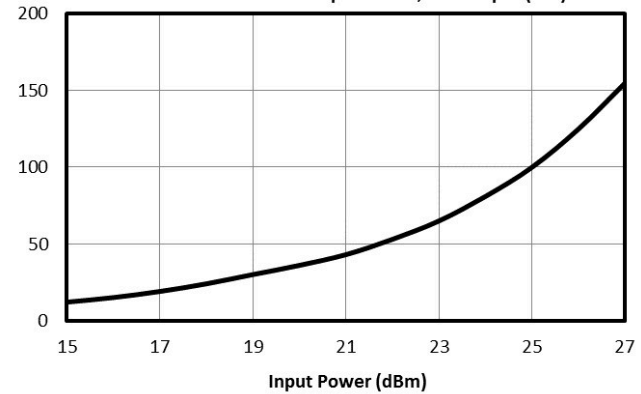




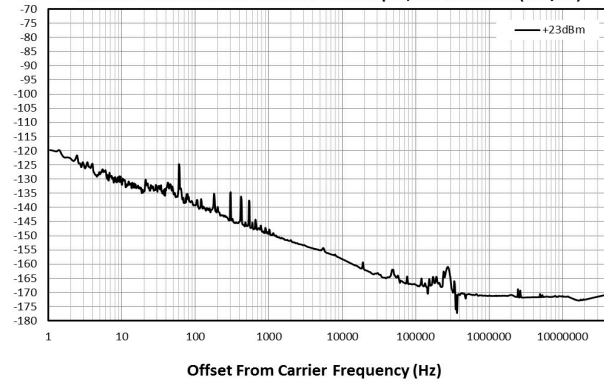
Output Power vs Input Power: 5 GHz Sine Wave Input (dBm)



DC Rectified Current v. Input Power, 1GHz Input (mA)

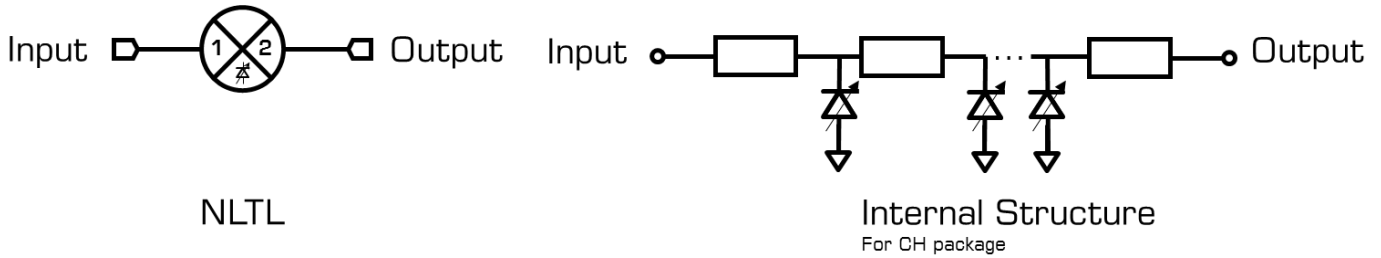


Residual Phase Noise: 1 GHz Sine Wave Input, 5th Harmonic (dBc/Hz)



1 GHz, +23 dBm Sine Wave Input	Parameter	Min	Typical	Max	Units
5 <sup>th</sup> Output Harmonic	1 Hz Offset		-120		dBc/Hz
	10 Hz Offset		-130		
	100 Hz Offset		-140		
	1 kHz Offset		-150		
	10 kHz Offset		-160		
	100 kHz Offset		-170		
	1 MHz Offset		Thermal Floor		

**Application Information**



NLTL-6273 belongs to Marki Microwave’s NLTL family of multipliers and non-linear transmission lines. The NLTL product line consists of passive GaAs MMIC non-linear transmission lines designed and fabricated with GaAs Schottky diode based varactors. NLTLs take an input signal and create an impulse train of harmonics. Harmonic outputs up to and beyond 40 GHz are generated by the NLTL. The NLTL-6273SM is the packaged 5 mm QFN version of the NLTL-6273CH.

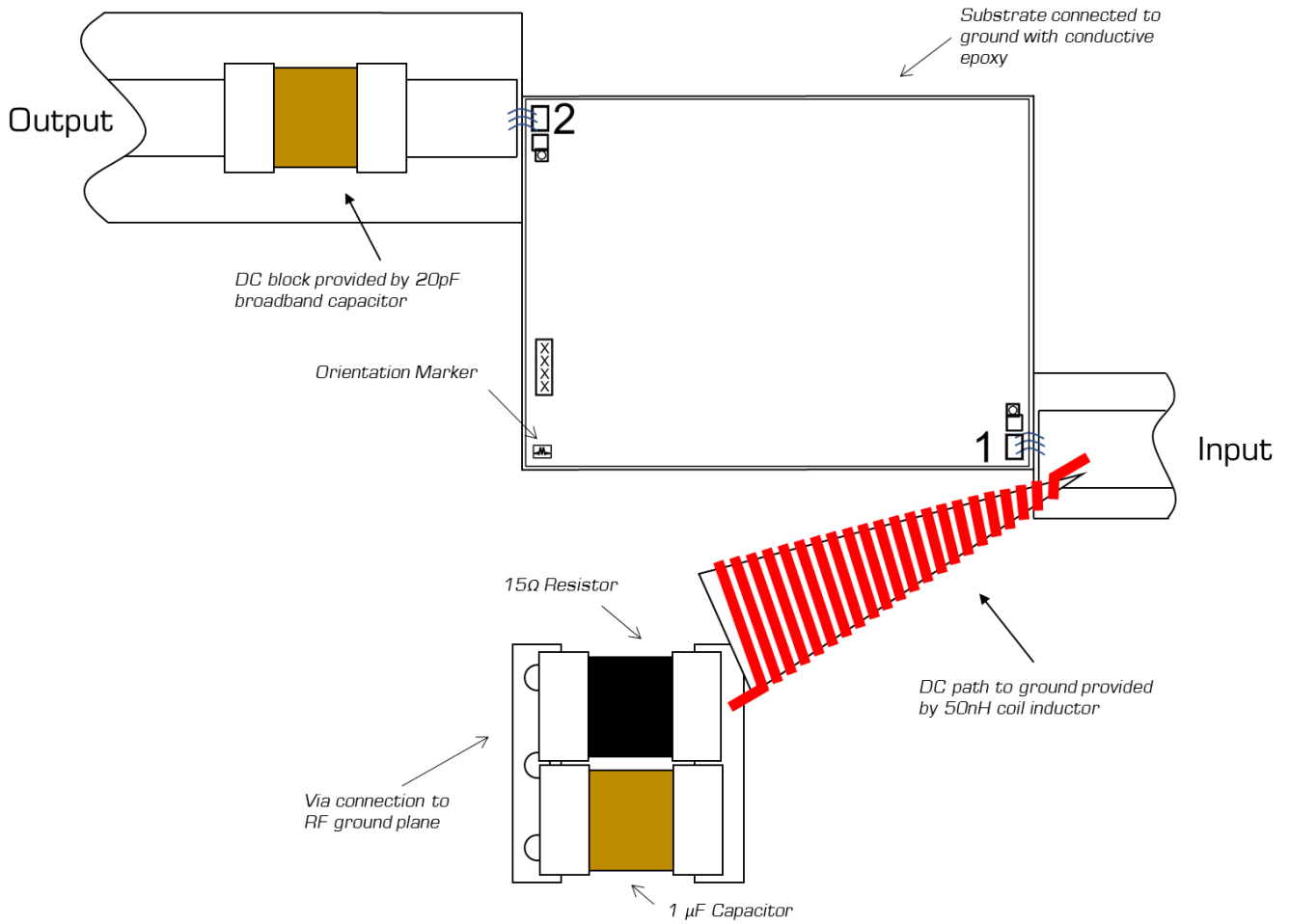
Port 1 supports L and S band input signals. Port 2 will output integer multiples of the input signal (i.e., x2, x3, x4, ..., x30) up to the 30th output harmonic or a maximum of 40 GHz. Higher harmonics can be generated but will be at a lower efficiency.

The operating conditions of the NLTL are extremely important to optimize performance. High power inputs will increase the output power observed; however, the conversion efficiency will decrease. This is increasingly true for higher input frequencies and at input powers above the recommended limit. Optimal conversion efficiency of the NLTL is achieved using a square wave input with a fast rise time. Doing so causes a degradation in the 2nd output harmonic but otherwise improves the conversion efficiency at all other harmonics.

NLTL-6273 requires no external DC bias. The self-bias of the diodes caused by the rectified RF input signal is sufficient for operation. For the best performance, optimization of the DC return path is recommended for each specific application to optimize the harmonic output power distribution.

The phase noise of a non-linear transmission line is outstanding. If verification of performance is necessary, the application circuit used and input conditions are extremely important. NLTLs are AM sensitive. If there is excessive AM noise on the input of the NLTL, observing the output of the NLTL will show excessive PM/phase noise because of the high AM to PM conversion property of NLTLs.

**Application Circuit**



#### Application Circuit Description

**DC Path to Ground** – An RF choke followed by a 15  $\Omega$  resistor should be used to provide a DC path to ground on the input port of the NLTL. A shunt 1  $\mu\text{F}$  capacitor is used to filter noise generated by the resistor. This forms the circuit which self-biases the NLTL. The DC return to ground removes DC rectified current created by high power RF signal injection. The DC path to ground is provided within the S package. A conical coil inductor is recommended to push the self-resonance frequency of the inductor past the operating bandwidth of the NLTL. The recommended inductance value of the conical coil inductor is 50nH or higher.

**Blocking Capacitor** – A DC blocking capacitor on the output of the NLTL-6273's integrated circuit is necessary to prevent unwanted DC current flow from or to the output. If there is a DC signal on the input, place a DC block on the input to avoid disrupting the self-biasing of the diodes.

## Die Mounting Recommendations

### Mounting and Bonding Recommendations

Marki MMICs should be attached directly to a ground plane with conductive epoxy. The ground plane electrical impedance should be as low as practically possible. This will prevent resonances and permit the best possible electrical performance. Datasheet performance is only guaranteed in an environment with a low electrical impedance ground.

**Mounting** - To epoxy the chip, apply a minimum amount of conductive epoxy to the mounting surface so that a thin epoxy fillet is observed around the perimeter of the chip. Cure epoxy according to manufacturer instructions.

**Wire Bonding** - Ball or wedge bond with 0.025 mm (1 mil) diameter pure gold wire. Thermosonic wirebonding with a nominal stage temperature of 150 °C and a ball bonding force of 40 to 50 grams or wedge bonding force of 18 to 22 grams is recommended. Use the minimum level of ultrasonic energy to achieve reliable wirebonds. Wirebonds should be started on the chip and terminated on the package or substrate. All bonds should be as short as possible <0.31 mm (12 mils).

**Circuit Considerations** – 50  $\Omega$  transmission lines should be used for all high frequency connections in and out of the chip. Wirebonds should be kept as short as possible, with multiple wirebonds recommended for higher frequency connections to reduce parasitic inductance. In circumstances where the chip more than .001" thinner than the substrate, a heat spreading spacer tab is optional to further reduce bondwire length and parasitic inductance.

## Handling Precautions

### General Handling

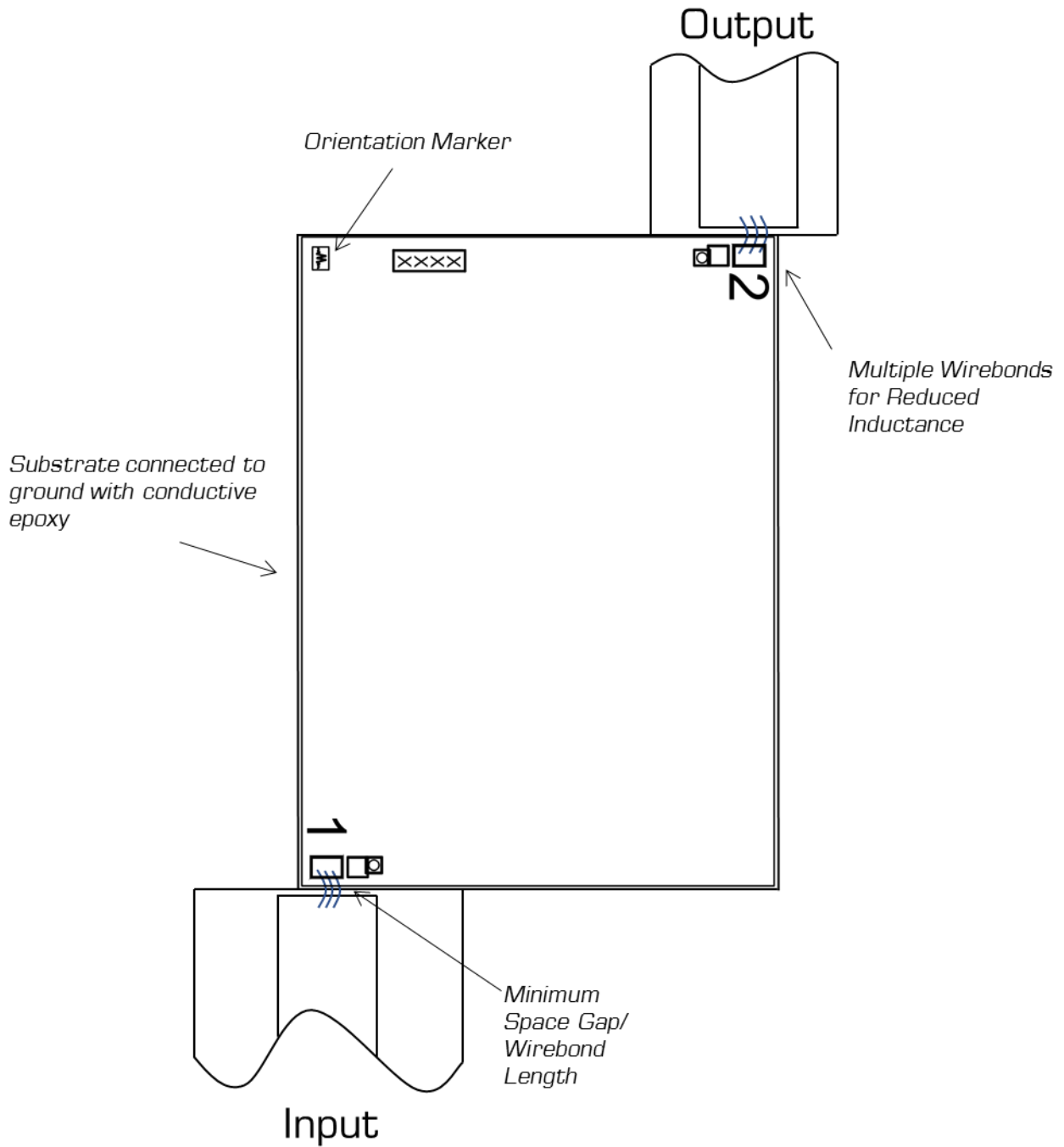
Chips should be handled with care using tweezers or a vacuum collet. Users should take precautions to protect chips from direct human contact that can deposit contaminants, like perspiration and skin oils on any of the chip's surfaces.

### Static Sensitivity

GaAs MMIC devices are sensitive to ESD and should be handled, assembled, tested, and transported only in static protected environments.

**Cleaning and Storage:** Do not attempt to clean the chip with a liquid cleaning system or expose the bare chips to liquid. Once the ESD sensitive bags the chips are stored in are opened, chips should be stored in a dry nitrogen atmosphere.

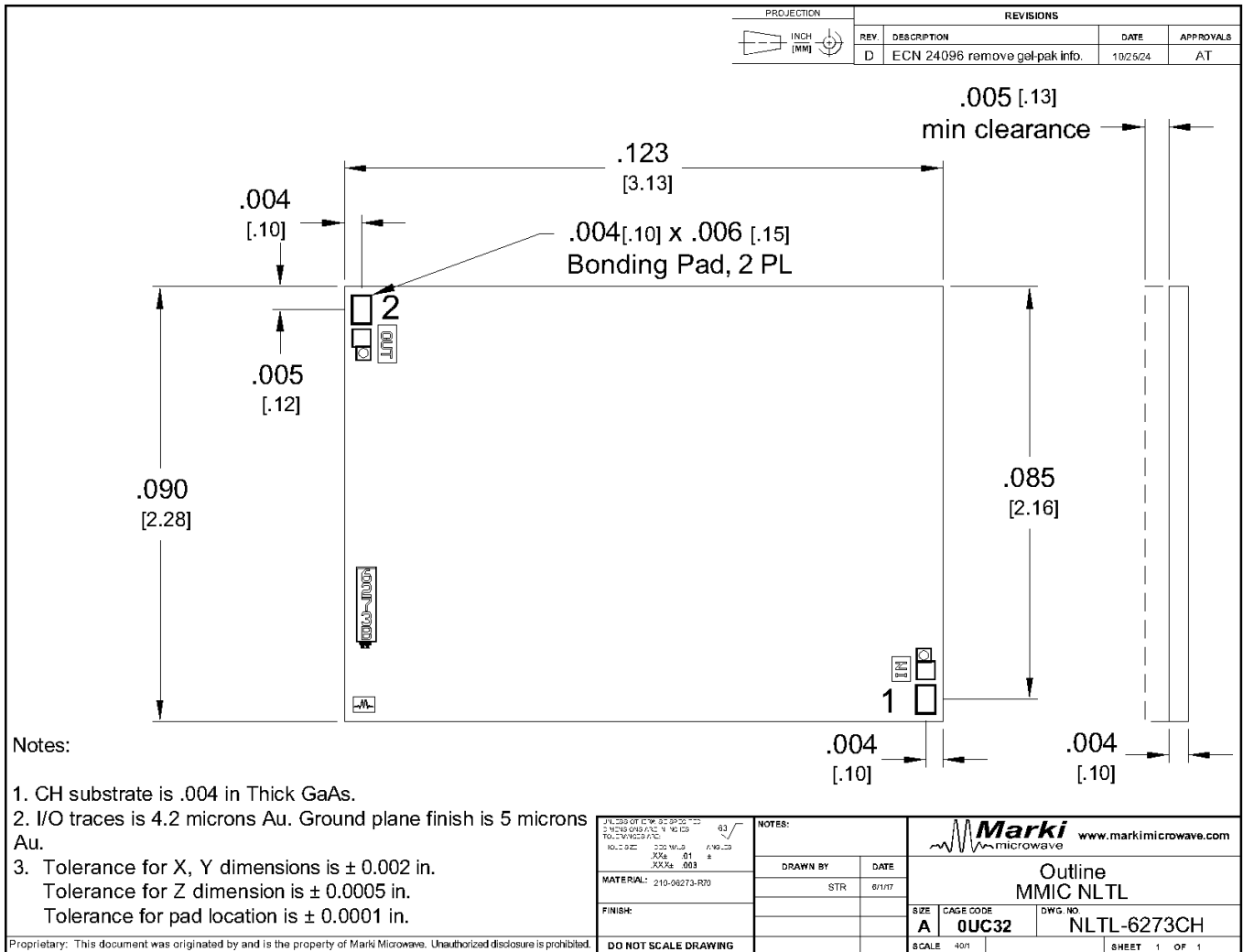
**Bonding Diagram**



**Mechanical Data**

**Outline Drawing**

Download : [Outline 2D Drawing](#)



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